

19/731726	Subclass					PATENT NUMBER
	Class					
U.S. UTILITY Patent Application						
DO NOT SEND TO ISSUE OR ABANDONED FILES Submit First to Licensing and Review			I.P.E. H.Kim		PATENT DATE	
REV. PTO-1305	DOE	NASA US COMM-DC	SCANNED S83	Q.A. AA		
APPLICANTS TITLE	APPLICATION NO. 09/731726	CONT/PRIOR F	CLASS 251148	SUBCLASS 400	ART UNIT 2811 1742	EXAMINER Ip
BEST AVAILABLE COPY						
Solder alloy, a circuit substrate, a semiconductor device and a method of manufacturing the same						
PTO-2040 12/89						

ISSUING CLASSIFICATION

WARNING:

The information disclosed herein may be restricted: Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368. Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.

Form PTO-438A
(Rev. 8/88)

FILED WITH: DISK/CD-R FICHE CD-ROM

ACNE COMEDONES

(Attached in pocket on right inside flap)

(FACE)